#### 1. General Description

TheMRF24G04Bmodulisdesignedfor2.4GHz ISMbandwith18-20dBm output power wireless applications usingAMICCOM's A7130 FSK/GFSKtransceiverand PA AP1110 RFIC. This module features a fully programmable frequency synthesizer by SPI. The data rate is 4Mbps.

#### 2. Electrical specification

Item	Specification	Remark
Suplyvoltage	3.3V+/ - 0.1(V)	
Current consumption	4uA@Sleepmode.	typical
	0.3mA@ldlemode.	
	2.7mA@Stand - byMode.	
	12.5mA@PLL Mode.	
	125mA@Txpower=18dBm	
	31.3mA@Rxmode	
Frequency	2400- 2483.5MHz	ISMband
Transmitoutput power	18dBm-20dBm@roomtemperature	Typical
Rx sensitivity	- 89dBm @4Mmode,Dev=1MHz.	Typical,
		BER≦1E
		- 3
Modulation	2.4GHzFSK/GFSK	
Interface	11pin2.0mm header	
PCBDimension	22.1(L)x 21.45(W)x 3.8(H)mm3 withoutPCBantenna	
Operating temperature	- 40℃~ 85℃	
	(DependoncrystalSpec.,example:Forktype 10 $^{\circ}\mathrm{C}$ ~ 60 $^{\circ}\mathrm{C}$ )	

## **FCC Statement:**

This equipment has been tested and found to comply with the limits for Part 15 of the FCC rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energyand, if not installed and used in accordance with the instructions, may cause harmful interference radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment to an outlet on a circuit different from that to which the receiver is connected.

This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must acceptany interference received, including interference that may cause undesired operation.

Note: Modifications to this product will void the user's authority to operate this equipment.

### **RF Radiation Exposure Statement:**

- 1. This Transmitter must not be co located or operating in conjunction with any other antenna ortransmitter.
- 2. This equipment complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body.

## **FCC Information to OEM integrator**

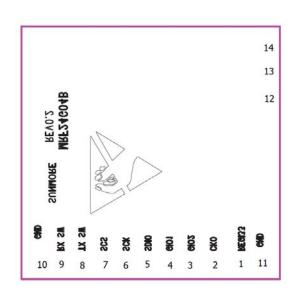
The OEM integrator has to be aware not to provide information to the end user regarding how toinstall or remove this RF module in the user manual of the end product.

The user manual which is provided by OEM integrators for end users must include the following information in a prominent location.

- 1.To comply with FCC RF exposure compliance requirements, the antenna used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co located or operating in conjunction with any other antenna or transmitter, except in accordance with FCC multi transmitter product procedures.
- 2. Only those antennas with same type and lesser gain filed under this FCC ID number can be used with this device.
- 3. The regulatory label on the final system must include the statement: "Contains FCC ID: xxxx orusing electronic labeling method as documented in KDB 784748.
- 4. The final system integrator must ensure there is no instruction provided in the user manual orcustomer documentation indicating how to install or remove the transmitter module except suchdevice has implemented two ways authentication between module and the host system

# The Installation instruction of the module:

# Pin descriptions



Pin No.	Pin name	Comment	Note
1	REGI33	RF module supply voltage input	3.3V
2	ско	Multi-function clock output.	
3	GIO2	General Purpose I/O 2	
4	GIO1	General Purpose I/O 1	
5	SDIO	SPI Data I/O	
6	SCK	SPI Clock	
7	SCS	SPI Chip Selection	
8	TX SW	RF front end select PA/LNA	
9	RX SW	RF front end select PA/LNA	
10	GND	GND	
11	GND	GND	
12	GND	GND	
13	RF	RF	
14	GND	GND	